# DT05 Rec'd PCT/PT0 2 5 QCT 2004

#### **Application Data Sheet**

### **Application Information**

Application Type:: Regular

Subject Matter:: Utility

Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None

Sequence submission?:: None

Computer Readable Form (CRF)?:: No

Title:: HIGH-RESISTANCE SILICON WAFER

AND ITS MANUFACTURING METHOD

Attorney Docket Number:: 474082002800

Request for Early Publication?:: No

Request for Non-Publication?:: No

Total Drawing Sheets:: 6

Small Entity?:: No

Petition included?:: No

Secrecy Order in Parent Appl.?:: No

#### **Applicant Information**

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Status:: Full Capacity

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Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

## **Foreign Priority Information**

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-127509	April 26, 2002	Yes
Japan	2002-360731	December 12, 2002	Yes

**Assignee Information** 

Assignee Name:: SUMITOMO MITSUBISHI SILICON

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